

## N-channel 600 V, 0.06 $\Omega$ typ., 42 A MDmesh™ M2 Power MOSFET in a TO-247 package

Datasheet - production data

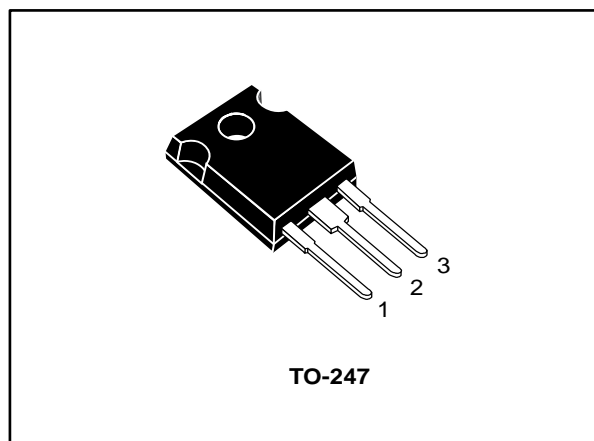
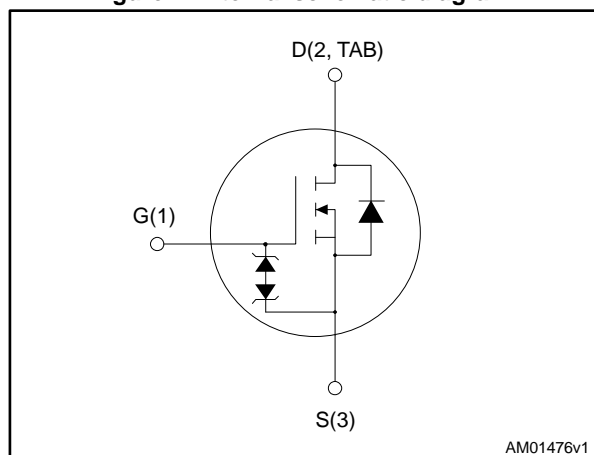


Figure 1: Internal schematic diagram



### Features

| Order code | V <sub>DS</sub> @ T <sub>Jmax</sub> . | R <sub>DS(on)</sub> max. | I <sub>D</sub> |
|------------|---------------------------------------|--------------------------|----------------|
| STW48N60M2 | 650 V                                 | 0.07 $\Omega$            | 42 A           |

- Extremely low gate charge
- Excellent output capacitance (C<sub>oss</sub>) profile
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications

### Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------|
| STW48N60M2 | 48N60M2 | TO-247  | Tube    |

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## Contents

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# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

| Symbol         | Parameter   | Value       | Unit             |
|----------------|---|-------------|------------------|
| $V_{GS}$       | Gate-source voltage   | $\pm 25$    | V                |
| $I_D$          | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$  | 42          | A                |
| $I_D$          | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$ | 26          | A                |
| $I_{DM}^{(1)}$ | Drain current (pulsed)  | 168         | A                |
| $P_{TOT}$      | Total dissipation at $T_C = 25\text{ }^\circ\text{C}$           | 300         | W                |
| $dv/dt^{(2)}$  | Peak diode recovery voltage slope                               | 15          | V/ns             |
| $dv/dt^{(3)}$  | MOSFET $dv/dt$ ruggedness                                       | 50          | V/ns             |
| $T_{stg}$      | Storage temperature range                                       | - 55 to 150 | $^\circ\text{C}$ |
| $T_j$          | Operating junction temperature range                            |             |                  |

**Notes:**

(1) Pulse width limited by safe operating area.

(2)  $I_{SD} \leq 42\text{ A}$ ,  $di/dt \leq 400\text{ A}/\mu\text{s}$ ;  $V_{DS(\text{peak})} < V_{(BR)DSS}$ ,  $V_{DD} = 400\text{ V}$

(3)  $V_{DS} \leq 480\text{ V}$

**Table 3: Thermal data**

| Symbol                | Parameter                                | Value | Unit                      |
|-----------------------|--|-------|---------------------------|
| $R_{thj\text{-case}}$ | Thermal resistance junction-case max.    | 0.42  | $^\circ\text{C}/\text{W}$ |
| $R_{thj\text{-amb}}$  | Thermal resistance junction-ambient max. | 50    | $^\circ\text{C}/\text{W}$ |

**Table 4: Avalanche characteristics**

| Symbol   | Parameter  | Value | Unit |
|----------|--|-------|------|
| $I_{AR}$ | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{j\text{max}}$ .)                         | 7     | A    |
| $E_{AS}$ | Single pulse avalanche energy (starting $T_j = 25\text{ }^\circ\text{C}$ , $I_D = I_{AR}$ ; $V_{DD} = 50\text{ V}$ ) | 1     | J    |

## 2 Electrical characteristics

( $T_C = 25\text{ °C}$  unless otherwise specified)

**Table 5: On /off-states**

| Symbol        | Parameter                         | Test conditions  | Min. | Typ. | Max.     | Unit          |
|---------------|-----------------------------------|--|------|------|----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0, I_D = 1\text{ mA}$                                | 600  |      |          | V             |
| $I_{DSS}$     | Zero-gate voltage drain current   | $V_{GS} = 0, V_{DS} = 600\text{ V}$                            |      |      | 1        | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0, V_{DS} = 600\text{ V}, T_C = 125\text{ °C}^{(1)}$ |      |      | 100      | $\mu\text{A}$ |
| $I_{GSS}$     | Gate-body leakage current         | $V_{DS} = 0, V_{GS} = \pm 25\text{ V}$                         |      |      | $\pm 10$ | $\mu\text{A}$ |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$                | 2    | 3    | 4        | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}, I_D = 21\text{ A}$                      |      | 0.06 | 0.07     | $\Omega$      |

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test.

**Table 6: Dynamic**

| Symbol                     | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit     |
|----------------------------|-------------------------------|---|------|------|------|----------|
| $C_{iss}$                  | Input capacitance             | $V_{GS} = 0, V_{DS} = 100\text{ V}, f = 1\text{ MHz}$   | -    | 3060 | -    | pF       |
| $C_{oss}$                  | Output capacitance            |   | -    | 143  | -    | pF       |
| $C_{rss}$                  | Reverse transfer capacitance  |   | -    | 4.3  | -    | pF       |
| $C_{oss\text{ eq.}}^{(1)}$ | Equivalent output capacitance | $V_{GS} = 0, V_{DS} = 0\text{ to }480\text{ V}$   | -    | 630  | -    | pF       |
| $R_G$                      | Intrinsic gate resistance     | $f = 1\text{ MHz}, I_D = 0$   | -    | 4.6  | -    | $\Omega$ |
| $Q_g$                      | Total gate charge             | $V_{DD} = 480\text{ V}, I_D = 42\text{ A}, V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 15: "Test circuit for gate charge behavior"</a> ) | -    | 70   | -    | nC       |
| $Q_{gs}$                   | Gate-source charge            |   | -    | 10.5 | -    | nC       |
| $Q_{gd}$                   | Gate-drain charge             |   | -    | 31   | -    | nC       |

**Notes:**

<sup>(1)</sup> $C_{oss\text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 7: Switching times

| Symbol       | Parameter           | Test conditions  | Min. | Typ. | Max. | Unit |
|--------------|---------------------|--|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300\text{ V}$ , $I_D = 21\text{ A}$ ,<br>$R_G = 4.7\ \Omega$ , $V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 14: "Test circuit for resistive load switching times"</a> and<br><a href="#">Figure 19: "Switching time waveform"</a> ) | -    | 18.5 | -    | ns   |
| $t_r$        | Rise time           |  | -    | 17   | -    | ns   |
| $t_{d(off)}$ | Turn-off-delay time |  | -    | 13   | -    | ns   |
| $t_f$        | Fall time           |  | -    | 119  | -    | ns   |

Table 8: Source-drain diode

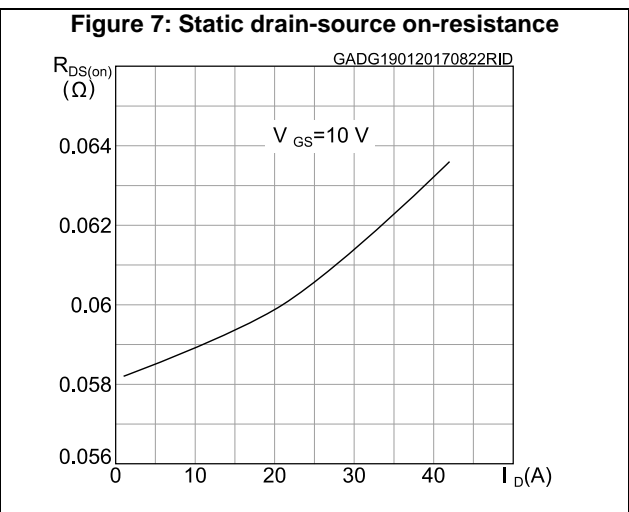
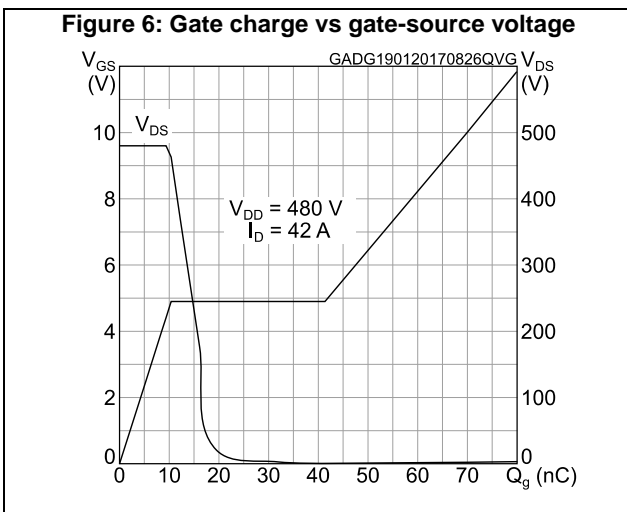
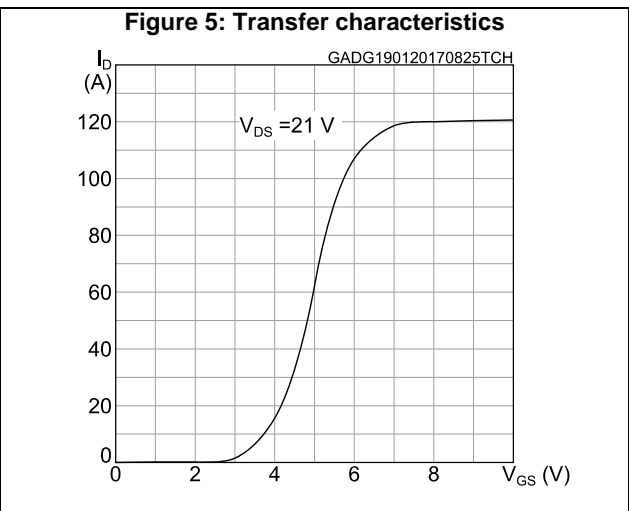
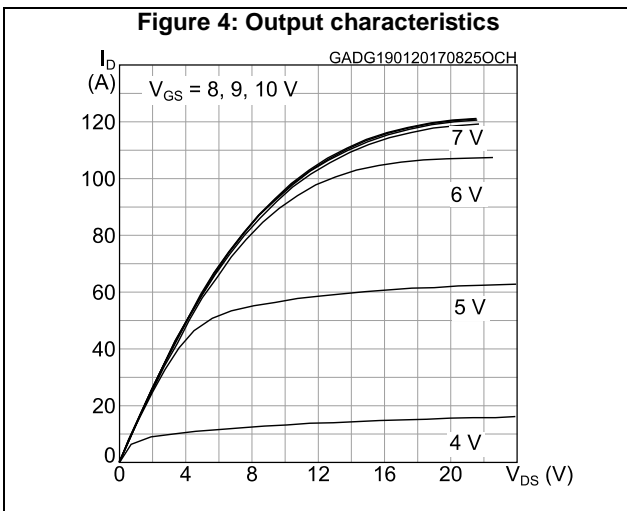
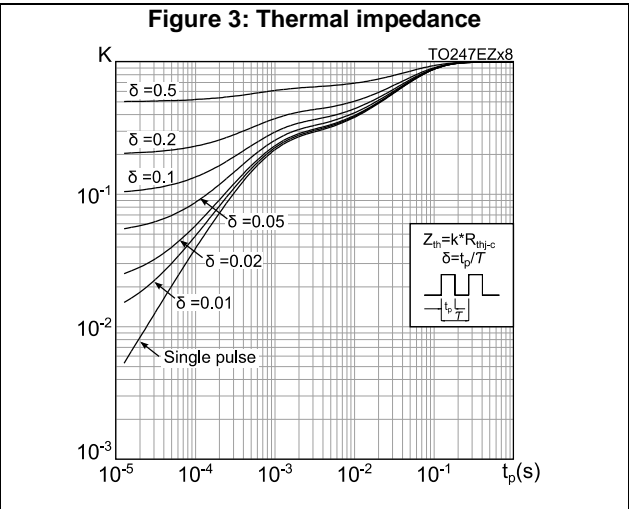
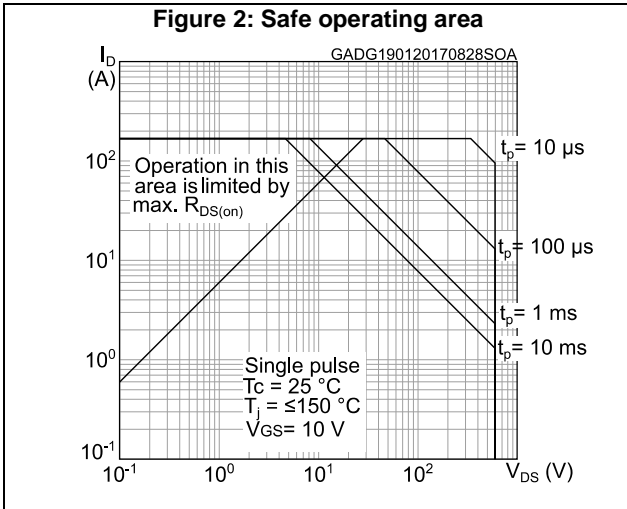
| Symbol          | Parameter                     | Test conditions  | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|--|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |  | -    |      | 42   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |  | -    |      | 168  | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS} = 0$ , $I_{SD} = 21\text{ A}$  | -    |      | 1.6  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 42\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 60\text{ V}$ (see <a href="#">Figure 17: "Unclamped inductive load test circuit"</a> )  | -    | 487  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |  | -    | 9.1  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  | -    | 37.5 |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 42\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 60\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$<br>(see <a href="#">Figure 17: "Unclamped inductive load test circuit"</a> ) | -    | 605  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |  | -    | 12.5 |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  | -    | 41.5 |      | A             |

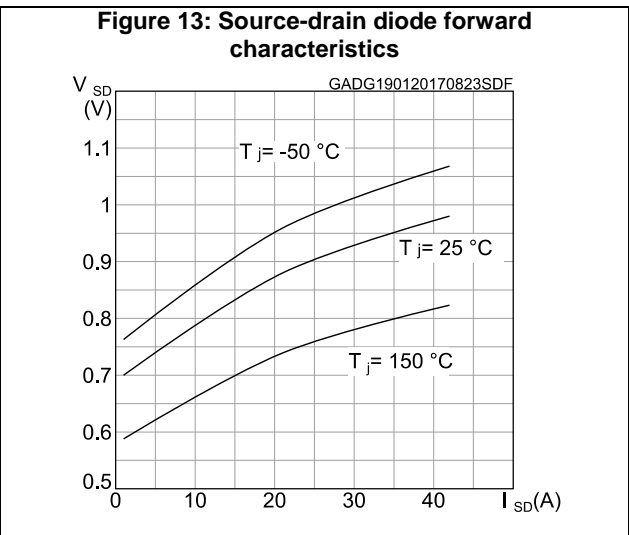
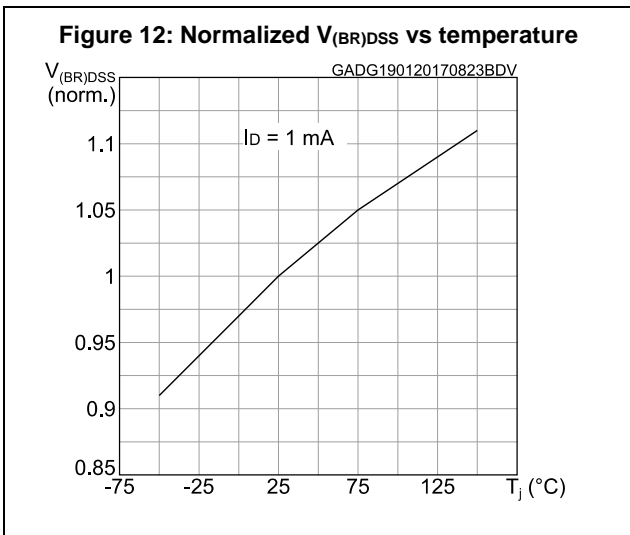
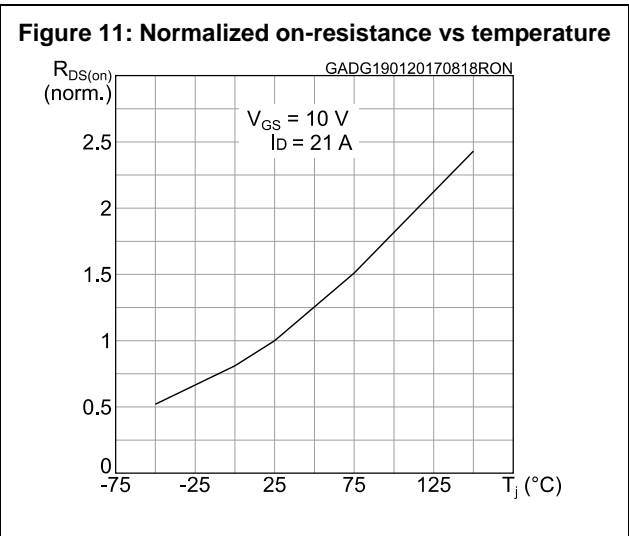
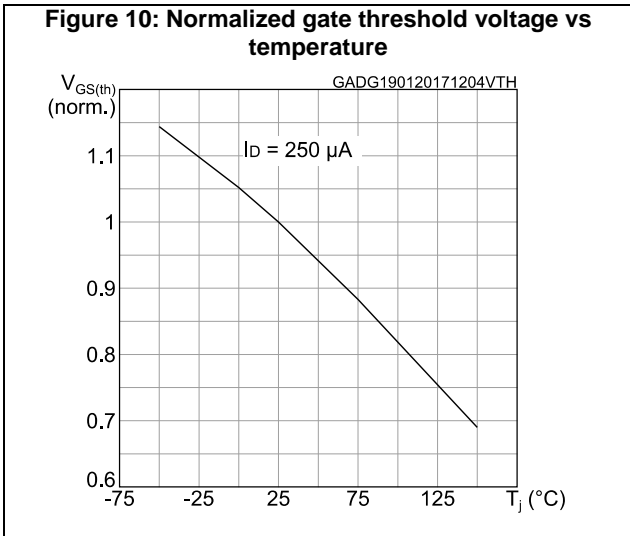
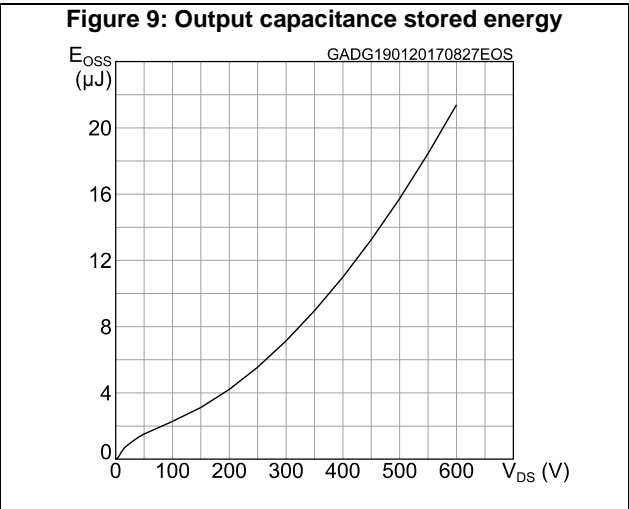
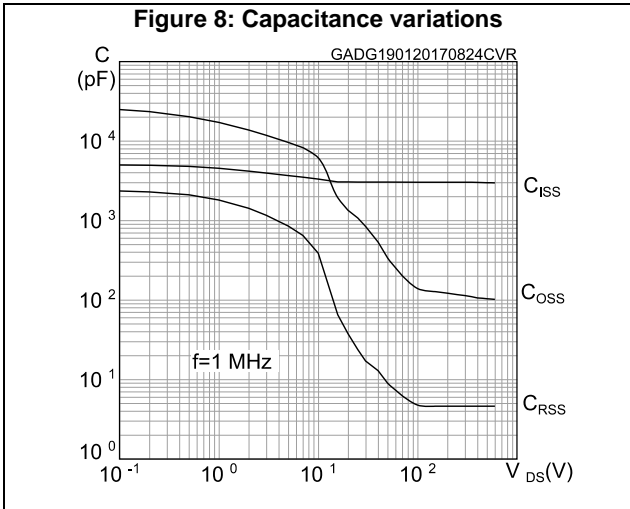
**Notes:**

(1)Pulse width limited by safe operating area.

(2)Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)





### 3 Test circuits

**Figure 14: Test circuit for resistive load switching times**



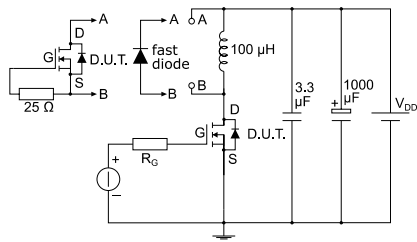
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**Figure 15: Test circuit for gate charge behavior**



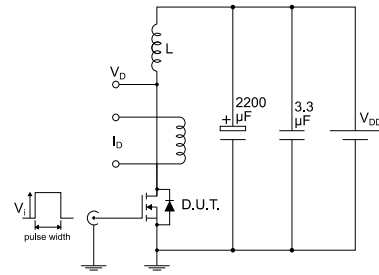
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**Figure 16: Test circuit for inductive load switching and diode recovery times**



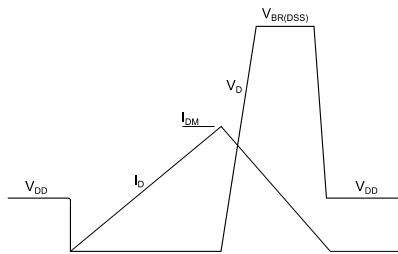
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**Figure 17: Unclamped inductive load test circuit**



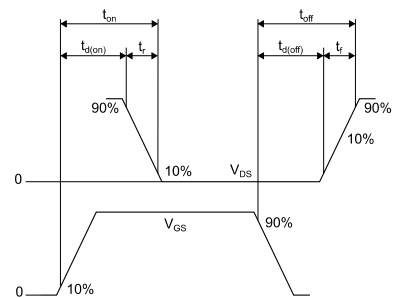
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**Figure 18: Unclamped inductive waveform**



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**Figure 19: Switching time waveform**



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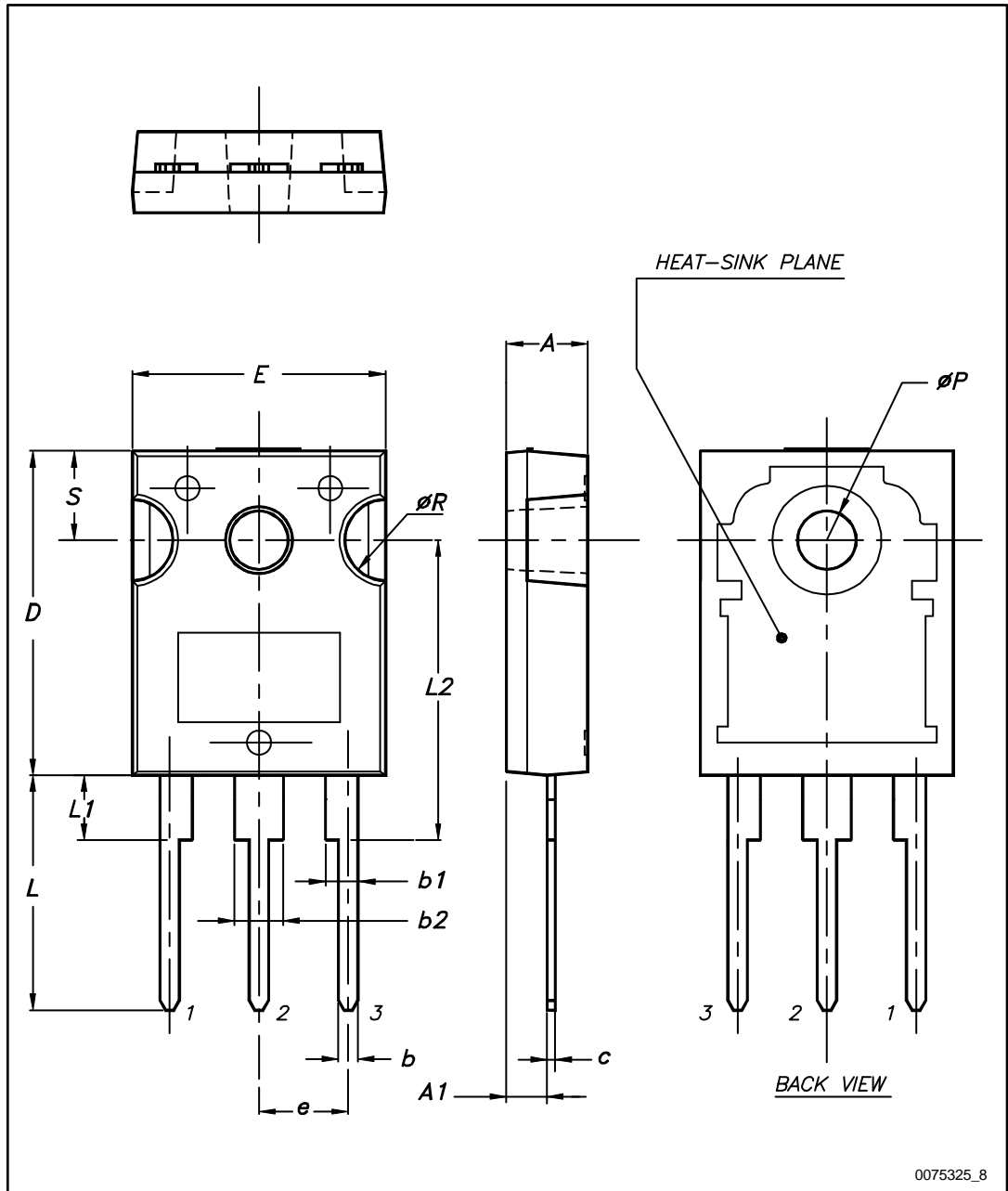


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-247 package information

Figure 20: TO-247 package outline



0075325\_8

Table 9: TO-247 package mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.85  |       | 5.15  |
| A1   | 2.20  |       | 2.60  |
| b    | 1.0   |       | 1.40  |
| b1   | 2.0   |       | 2.40  |
| b2   | 3.0   |       | 3.40  |
| c    | 0.40  |       | 0.80  |
| D    | 19.85 |       | 20.15 |
| E    | 15.45 |       | 15.75 |
| e    | 5.30  | 5.45  | 5.60  |
| L    | 14.20 |       | 14.80 |
| L1   | 3.70  |       | 4.30  |
| L2   |       | 18.50 |       |
| ØP   | 3.55  |       | 3.65  |
| ØR   | 4.50  |       | 5.50  |
| S    | 5.30  | 5.50  | 5.70  |

## 5 Revision history

Table 10: Document revision history

| Date        | Revision | Changes  |
|-------------|----------|--|
| 09-Jun-2014 | 1        | First release.   |
| 01-Sep-2014 | 2        | Document status promoted from preliminary to production data.<br>Added <i>Section 2.1: "Electrical characteristics curves"</i> .<br>Minor text changes.  |
| 19-Jan-2017 | 3        | Updated <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 4: "Avalanche characteristics"</i> , <i>Table 5: "On /off-states"</i> and <i>Table 7: "Switching times"</i> .<br>Updated <i>Section 2.1: "Electrical characteristics (curves)"</i> . |

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